

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









# Surge arrester

2-electrode arrester

Series/Type: ES1200XSMD Ordering code: B88069X5641T902

Date: 2015-07-10

Version: 03

© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



B88069X5641T902 Surge arrester

#### 2-electrode arrester ES1200XSMD

### **Features**

- Small size
- Very fast response time
- High current handling capability
- Stable performance over service life
- Low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

### **Applications**

- Modem
- Consumer electronics
- Tuner

### **Electrical specifications**

| Liectrical specifications   |   |              |
|---|---|--------------|
| DC spark-over voltage 1) 2) Tolerance Min. Max.   | 1200<br>±15<br>1020<br>1380   | V<br>%<br>V  |
| Impulse spark-over voltage at 1 kV/µs - for 99% of measured values - typical values of distribution   | < 1500<br>< 1400  | V            |
| Service life 10 operations $[5\times (+) \& 5\times (-)]$ 8/20 µs 100 operations $[50\times (+) \& 50\times (-)]$ 10/1000 µs 20 operations 10/1000 µs Insulation resistance at 100 $V_{DC}$ | 1<br>10<br>100<br>> 1   | kA<br>A<br>A |
| Capacitance at 1 MHz  | < 1   | pF           |
| Arc voltage at 1 A Glow to arc transition current Glow voltage at 0.1 A   | ~ 11<br>< 0.5<br>~ 130  | V<br>A<br>V  |
| Weight  | ~ 0.7   | g            |
| Operation and storage temperature   | -40 +90   | °C           |
| Climatic category (IEC 60068-1)   | 40/090/21   |              |
| Marking, red positive   | EPCOS ES 1200 YY O ES - Series 1200 - Nominal voltage YY - Year of production O - Non radioactive |              |
| Certifications UL 1449 (E319264)  |   | <i>7</i> L°  |

At delivery AQL 0.65 level II, DIN ISO 2859 In ionized mode

Terms in accordance with ITU-T Rec. K.12; IEC 61663-2 and IEC 61643-311.

PPD AB PD / PPD AB PM 2015-07-10

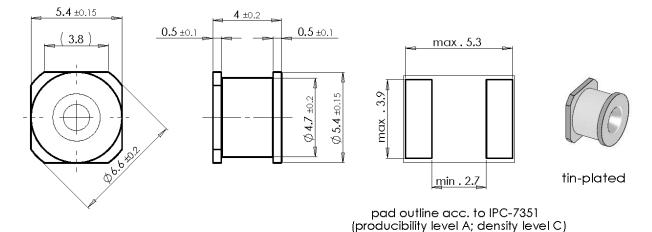


Surge arrester B88069X5641T902

### 2-electrode arrester

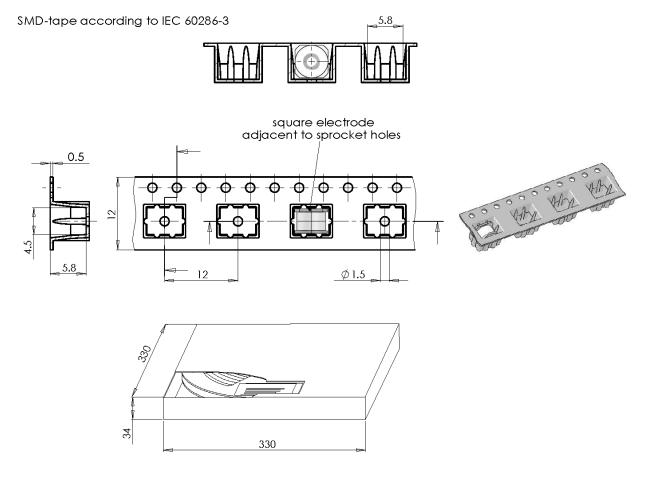
ES1200XSMD

### Dimensional drawing in mm



## Ordering code and packing advice

B88069X5641**T902** = SMD-tape with 900 pcs.



PPD AB PD / PPD AB PM 2015-07-10



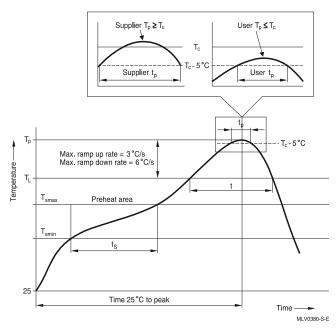
Surge arrester B88069X5641T902

### 2-electrode arrester

ES1200XSMD

### Soldering parameter

### Reflow soldering



| Reflow profile features  |   | Sn- Pb eutectic assembly     | Pb-free assembly             |
|--|---|------------------------------|------------------------------|
| Preheat and soak - Temperature min - Temperature max - Time  | $T_{smin} \\ T_{smax} \\ t_{smin} \text{ to } t_{smax}$ | 100 °C<br>150 °C<br>60 120 s | 150 °C<br>200 °C<br>60 180 s |
| Average ramp-up rate   | T <sub>smax</sub> to T <sub>p</sub>                     | max. 3 °C/ s                 | max. 3 °C/ s                 |
| Liquidous<br>temperature<br>Time at liquidous  | T <sub>L</sub>  | 183 °C<br>60 150 s           | 217 °C<br>60 150 s           |
| Peak package body<br>temperature *,<br>Classification<br>temperature **                                      | T <sub>p</sub> , T <sub>C</sub>                         | 220 235 °C **                | 245 260 °C **                |
| Time (t <sub>p</sub> ) ** within<br>5 °C of the specified<br>classification<br>temperature (T <sub>C</sub> ) |   | 20 s ***                     | 30 s ***                     |
| Average ramp-down rate   | T <sub>p</sub> to T <sub>smax</sub>                     | max. 6 °C/ s                 | max. 6 °C/ s                 |
| Time 25 °C to peak temperature   |   | max. 6 min                   | max. 8 min                   |

 <sup>\* =</sup> Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

### **Cautions and warnings**

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Electromagnetic fields and ionizing radiation may affect the electrical characteristics of the arrester. The impact of such effects (inductive and capacitive field distortion from adjacent components) must be avoided by appropriate circuit design measures.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- If the contacts of the surge arresters are defective, current load can cause sparks and loud noises.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

### Display of ordering codes for EPCOS products

The ordering code for one and the same EPCOS product can be represented differently in data sheets, data books, other publications, on the EPCOS website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes

PPD AB PD / PPD AB PM 2015-07-10

<sup>\*\* =</sup> For details please refer to JEDEC J-STD-020D.

<sup>\*\*\* =</sup> Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.



### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- 7. The trade names EPCOS, Alu-X, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PQSine, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, TFAP, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.